



SY5867Z

Dimming Interface Converter

Compatible With 0/1~10V Dimming Resistor Dimming And PWM Dimming

General Description

The SY5867Z is a dimming interface converter whose input signal can be a 0/1~10V dimming signal, resistor, or PWM signal. It recognizes the signal automatically. The final output of SY5867Z is a PWM signal which is used to control a dimmable CC regulator or drive an opto-coupler to achieve isolated dimming. The frequency of output PWM signal and the source current to passive 0~10V dimmer/Resistor can be set by external capacitor and resistor.

Features

- Compatible with 0/1~10V Dimming, Resistor Dimming and PWM Dimming
- Recognize Different Dimming Signal Automatically
- Integrate 60V LDO Module to Simplify External Circuit
- The Source Current for Passive 0~10V Dimmer Can Be Set
- Dimming to off Function Available
- The Frequency of Output Can Be Set
- Compact Package: SO8

Applications

- LED Lighting

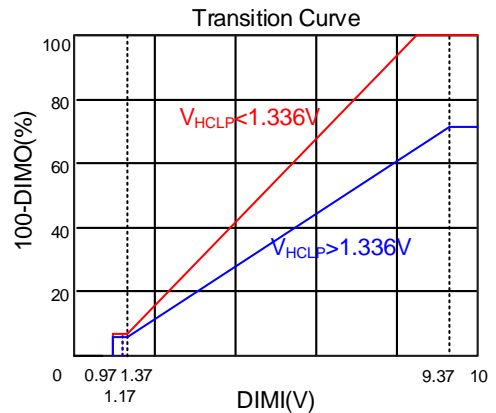
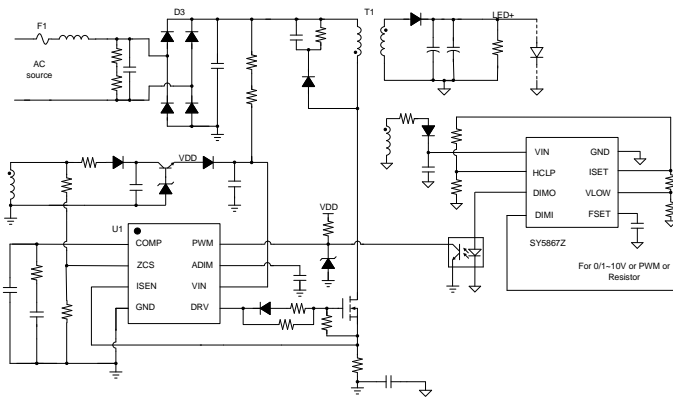


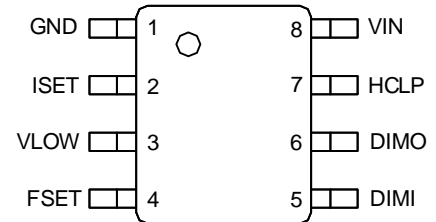
Fig. 1 Typical Application

Ordering Information

Ordering Part Number	Package type	Top Mark
SY5867ZFAP	SO8 RoHS-Compliant and Halogen-Free	AAFF xyz

x = year code, y = week code, z = lot number code

Pinout (top view)



Pin Description

Pin No	Pin Name	Pin Description
1	GND	Ground pin
2	ISET	Source current setting pin. V_{ISET} is a 2.21V voltage source. This pin is used to set the source current of DIMI pin for passive dimmer. $I_{sr} = \frac{5 \times 2.21}{R_{ISET}}$
3	VLOW	Low clamp setting pin. The minimum duty is set by V_{VLOW} , as showed below. $V_{VLOW} \leq 0.65V, D_{MIN} = \frac{1.023 - V_{VLOW}}{3 \cdot V_{HCLP} - V_{VLOW}} + 0.08 \times (V_{VLOW} - 0.75)^2$ $V_{VLOW} > 0.65V, D_{MIN} = \frac{1.023 - V_{VLOW}}{3 \cdot V_{HCLP} - V_{VLOW}}$
4	FSET	Dimming frequency setting pin. This pin is used to set the frequency of DIMO pin. $f_{DIM} = \frac{30 \cdot 10^{-6}}{(3 \cdot V_{HCLP} - V_{VLOW}) \cdot C_{FSET}}$
5	DIMI	Dimming input pin. Dimming signal is connected to this pin. It maybe is a 0/1~10V analog signal, resistor or a PWM signal.
6	DIMO	Dimming output pin. This pin will output a PWM signal to driver opto-coupler for separation dimming.
7	HCLP	High clamp setting pin. The maximum duty is set by V_{HCLP} , as showed below. $D_{MAX} = \frac{8.016 - 2 \times V_{VLOW}}{6 \cdot V_{HCLP} - 2 \cdot V_{VLOW}} - (V_{HCLP} - 1.8) \times 0.014$
8	VIN	Power supply pin. This pin provides power supply for IC.

Block Diagram

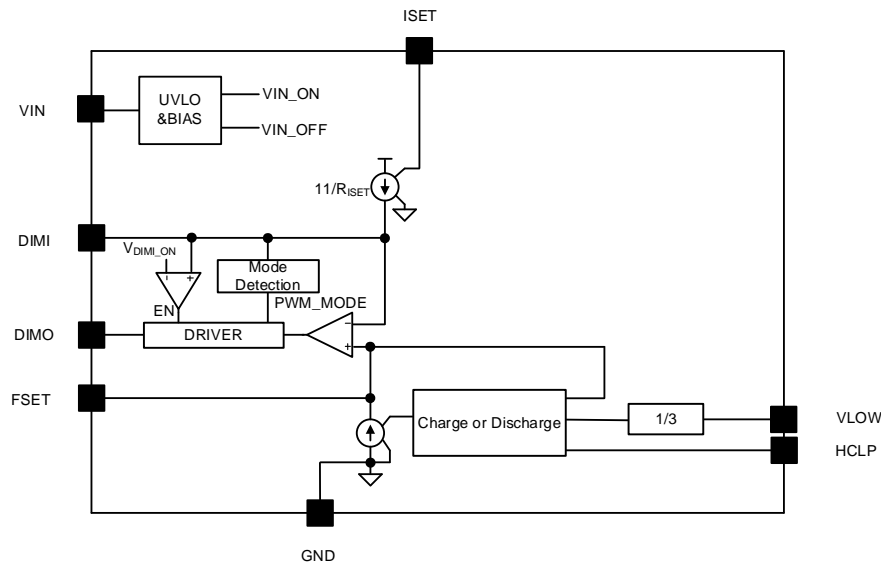


Fig.2 Block Diagram

Absolute Maximum Ratings

Parameter (Note 1)	Min	Max	Unit
VIN	-0.3	58	V
ISET, FSET, VLOW, HLCLP	-0.3	3.6	
DIMI, DIMO	-0.3	20	
Maximum Junction Temperature		125	°C
Lead Temperature (Soldering, 10 sec.)		260	
Storage Temperature Range	-65	150	

Thermal Information

Parameter (Note 2)	Min	Max	Unit
θ_{JA} Junction-to-ambient Thermal Resistance		88	°C/W
θ_{JC} Junction-to-case(top) thermal resistance		45	
P_D Power Dissipation $T_A = 25^\circ\text{C}$		1.1	W

ESD Rating

Parameter (Note 3)	Typ	Unit
V_{ESD_HBM} (Human Body Model, HBM), all pins	± 2000	V
V_{ESD_CDM} (Charged Device Model, CDM), all pins	± 500	V

Recommended Operating Conditions

Parameter (Note 3)	Min	Max	Unit
VIN, DRV	12	55	V
Junction Temperature	-40	125	°C

Electrical Characteristics

(T_J=-40 to 125°C, V_{CC}=15V (unless otherwise specified))

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit	
Power Supply	VIN Voltage Range	V _{VIN}		V _{VIN_ON}	55	V	
	VIN Turn-on Threshold	V _{VIN_ON}	8.3	9.1	9.9	V	
	VIN Turn-off Threshold	V _{VIN_OFF}	6.9	7.7	8.4	V	
DIMI	DIMI Source Current	I _{SR}	R _{ISET} =75Kohm	139	150	161	μA
	Ref Voltage of ISET	V _{ISET}	R _{ISET} =5.5Kohm	2.1	2.21	2.32	V
	Maximum Dimming Voltage	V _{HIGH}		9.22	9.37	9.52	V
	Minimum Dimming Voltage	V _{MIN}		1.27	1.37	1.47	V
	Max Duty of PWM Dimming (Note 4)	D _{PWM_MAX}			99(note 3)		%
	Min Duty of PWM Dimming(Note 4)	D _{PWM_MIN}			0		%
	Max Duty of 0~10V Dimming	D _{0-10V_MAX}	V _{DIMI} =10V V _{HCLP} =1.8V V _{VLOW} =0.75V	69	70.2	71.4	%
	Min Duty of 0~10V Dimming_1	D _{0-10V_MIN1}	V _{DIMI} =1.2V V _{HCLP} =1.8V V _{VLOW} =0.75V	4.5	6	7.5	%
	Min Duty of 0~10V Dimming_2	D _{0-10V_MIN2}	V _{DIMI} =1.2V V _{HCLP} =1.31V V _{VLOW} =0.75V	7	8.8	10.6	%
	PWM ON Voltage Threshold	V _{PWM_ON}				2.3	V
	PWM OFF Voltage Threshold	V _{PWM_OFF}		0.8			V
	DIMI ON Voltage Threshold	V _{DIMI_ON}		1.12	1.17	1.22	V
DIMI OFF Voltage Threshold	V _{DIMI_OFF}		0.92	0.97	1.02	V	
Thermal	Thermal shut down Temperature	T _{SD}			145	°C	

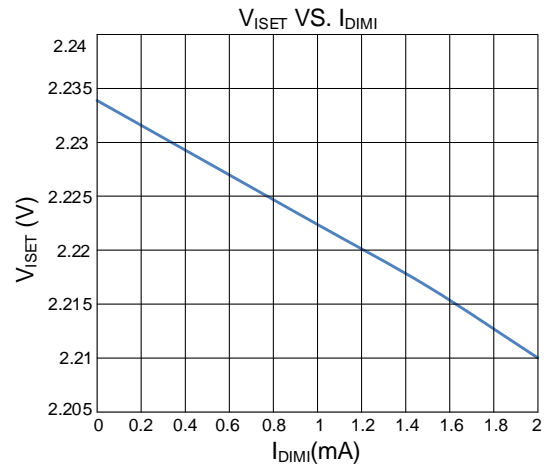
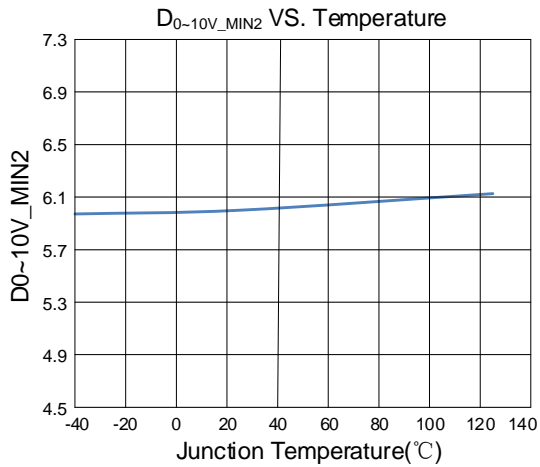
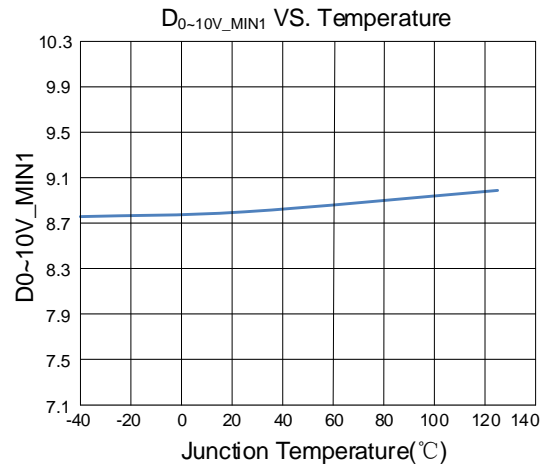
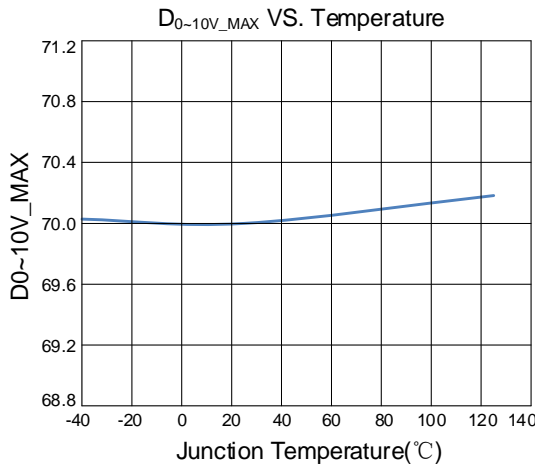
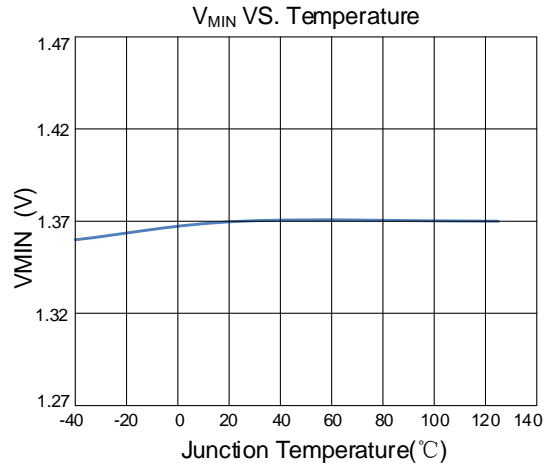
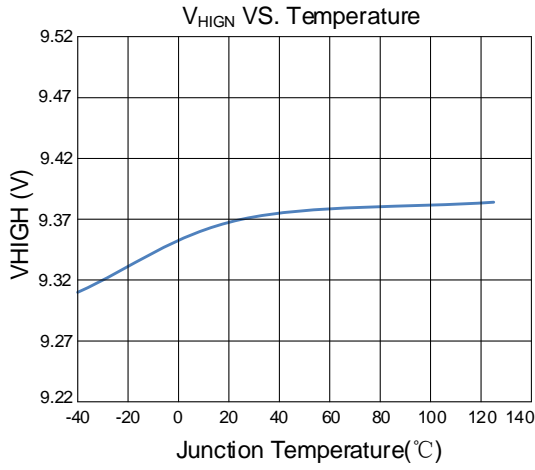
Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ_{JA} is measured in the natural convection at T_A = 25°C on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Test condition: Device mounted on 2” x 2” FR-4 substrate PCB, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.

Note 3: If PWM duty is 100% and its amplitude is not 10V, SY5867Z could not recognize the current state is PWM mode or not. But if the amplitude of PWM is 10V, the maximum duty is 100%.

Note 4: Guarantee by design.

Typical Performance Characteristics



Operation

The SY5867Z is a dimming interface converter whose input signal can be a 0/1~10V dimming signal, resistor, or PWM signal. It recognizes the signal automatically.

When input signal is 0/1~10V dimming signal, It will be converted into a PWM signal to driver opto-coupler or dimmable IC. SY5867Z can achieve dim to off function.

When input signal is a resistor, there is a current flowing out from DIMI pin to produce a voltage at the resistor. Then It works as same as 0/1~10V dimming input.

When input signal is a PWM signal, it is converted into a reverse PWM signal.

There are two working modes: Low-clamp is used to clamp the minimum duty cycle. High-clamp is used to clamp the maximum duty cycle. Two working modes can be set by VLOW pin and HCLP pin respectively.

More detail information is discussed below.

Applications Information

Start up

Supposing DIMI is floating.

DIMO is Low before VIN reach V_{IN_ON} . After VIN reaching V_{IN_ON} , IC begin to work and DIMO is regulated by DIMI.

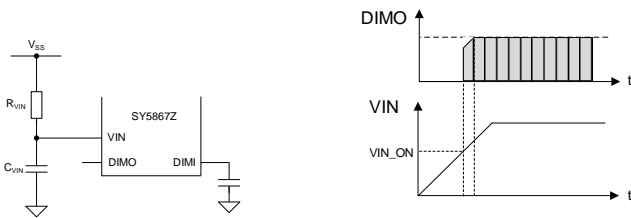


Fig.3 Start up

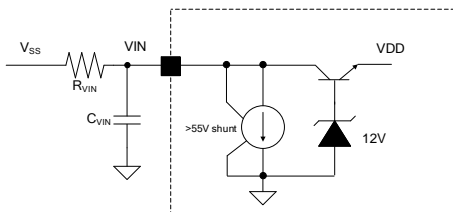


Fig.4 Internal LDO

The IC integrates a 60V LDO for simplifying peripheral device. There is a shunt current if VIN voltage is larger than 55V which helps to protect IC when power voltage is high than 55V.

Dimming Input

(1) 0/1~10V Dimming

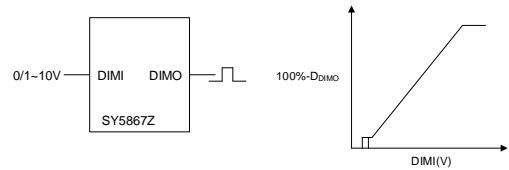


Fig.5 0/1~10V Dimming

If input signal of DIMI pin is 0/1~10V, it is converted into reversed duty signal.

(2) Resistor Dimming

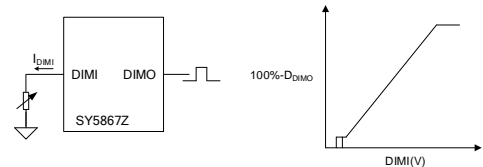


Fig.6 Resistor Dimming

If DIMI is connected with a variable resistor, there is a current flow from DIMI pin to drive the resistor and produce 0~10V signal. Also, the current exists in 0/1~10V dimming application.

(3) PWM Dimming

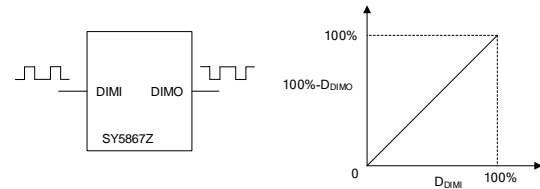


Fig.7 PWM Dimming

If input dimming signal is PWM signal, IC converts it into a reversed PWM signal.

Working Mode Setting

(1) High clamp mode

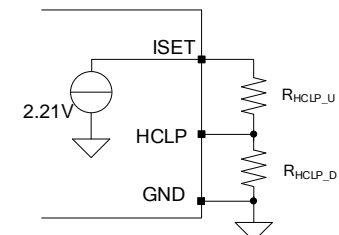


Fig.8 High clamp mode setting

As showed above, High clamp mode is used to set the maximum duty which can regulate the full load current in some special application.

If the voltage of HCLP pin is larger than 1.336V. The turning point of DIMI is always 9.37V, and the maximum duty can be calculated by the following formula.

$$D_{MAX} = \frac{8.016 - 2 \cdot V_{VLOW}}{6 \cdot V_{HCLP} - 2 \cdot V_{VLOW}}$$

With different R_{HCLP_U} and R_{HCLP_D} , the maximum duty is set. The design result is showed as bellow.

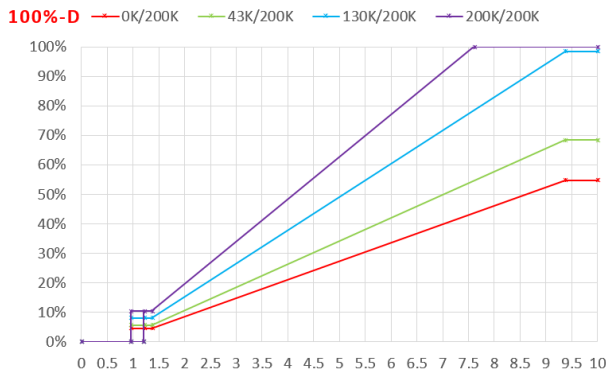


Fig.9 High clamp mode design result

(2) Low Clamp Mode

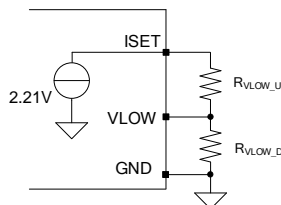


Fig.10 Low clamp mode setting

As showed above, Low clamp mode is used to set the minimum duty which can regulate the light load current in some special application.

If the voltage of VLOW pin is less than 1.023V, The turning point of DIMI is always 1.36V, and the minimum duty can be calculated by the following formula.

$$D_{MIN} = \frac{1.023 - V_{VLOW}}{3 \cdot V_{HCLP} - V_{VLOW}}$$

In Low Clamp Mode, SY5867Z is Dimmed to off and duty cycle is force to zero when $V_{DIMI} < V_{DIMI_OFF}$ (0.97V typically). While V_{DIMI} is increase from V_{DIMI_OFF} to V_{DIMI_ON} (1.17V typically), SY5867Z is Dimmed to on and DIMO is regulated by DIMI.

With different R_{VLOW_U} and R_{VLOW_D} , the minimum duty is set. The design result is showed as bellow.

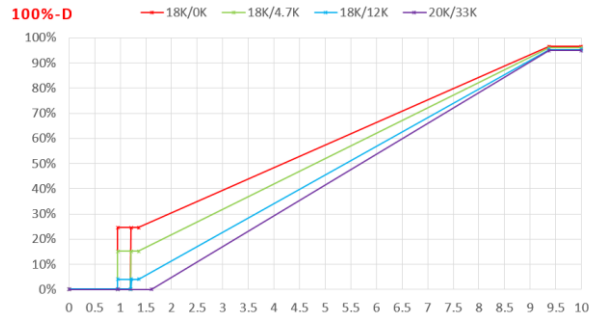


Fig.11 Low clamp mode design result

5. Curve translation

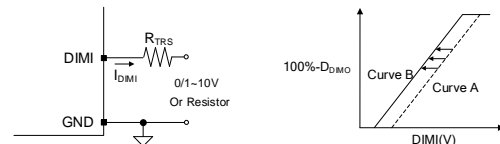


Fig.12 Curve Translation Setting

To translate the converted curve, R_{TRS} is set. With greater R_{TRS} , converted curve is changed from A to B as showed above.

6. DIMI Current Set

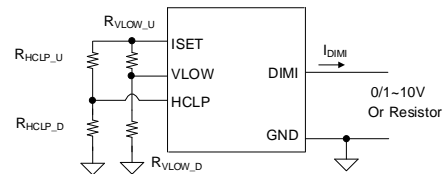


Fig.13 DIMI current setting

If the dimmer is passive device or a resistor, there should be a drive current to power the dimmer.

The current is set by:

$$I_{DIMI} = \frac{5 \times 2.21}{R_{ISET}}$$

$$R_{ISET} = (R_{HCLP_U} + R_{HCLP_D}) // (R_{VLOW_U} + R_{VLOW_D})$$

7. Frequency setting

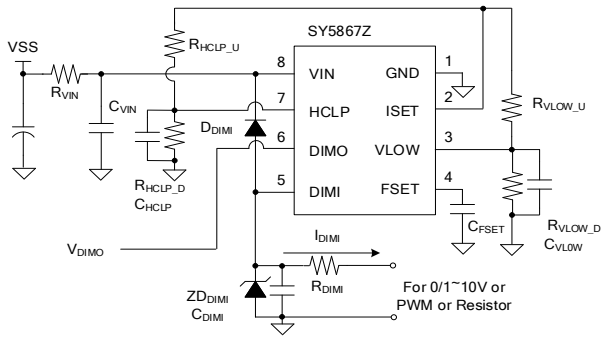
There is a 20uA current charge or discharge FSET capacitor to produce a reference triangle wave.

The frequency is set by:

$$f_{DIM} = \frac{30 \cdot 10^{-6}}{(3 \cdot V_{HCLP} - V_{LOW}) \cdot C_{FSET}}$$

8. Recommended Peripheral Circuit

Fig.14 Recommended Circuit



C_{DIMI} is the DIMI pin capacitor and 100pF is recommended. R_{VIN} & C_{VIN} is the VCC resistor and capacitor and 1K Ω & 1nF is recommended. D_{DIMI} is the DIMI pin protecting Diode and 1N4148 is chosen usually.

Design Example

A design example of typical application is shown below step by step.

#1. Identify design specification

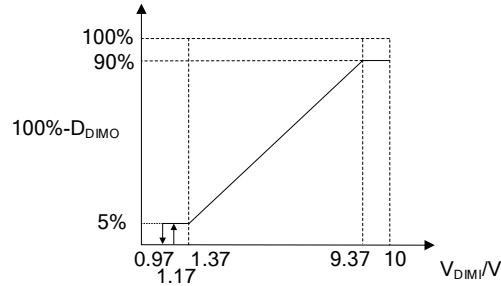


Fig. 15 Target Curve

Target parameter			
I_{DIM1}	500uA	fs	1kHz
V_{LOW}	1.37	D_{MIN}	5%
V_{HIGH}	9.37	D_{MAX}	90%

#2. V_{LOW} calculation:

Set $R_{V_{LOW_D}} = 20K$;

Because,

$$\begin{cases} D_{MIN} = \frac{1.023 - V_{V_{LOW}}}{3 \cdot V_{HCLP} - V_{V_{LOW}}} \\ D_{MAX} = \frac{8.016 - 2 \cdot V_{V_{LOW}}}{6 \cdot V_{HCLP} - 2 \cdot V_{V_{LOW}}} \end{cases}$$

So,

$$\frac{D_{MIN}}{D_{MAX}} = \frac{2 \times (1.023 - V_{V_{LOW}})}{8.016 - 2 \cdot V_{V_{LOW}}} \rightarrow \frac{5\%}{90\%} = \frac{2 \times (1.023 - V_{V_{LOW}})}{8.016 - 2 \times V_{V_{LOW}}} \rightarrow V_{V_{LOW}} = 0.847V$$

$$R_{V_{LOW_U}} = \frac{(2.21 - V_{V_{LOW}}) \times R_{V_{LOW_D}}}{V_{V_{LOW}}} = 31.92K$$

Set

$$\begin{cases} R_{V_{LOW_U}} = 33K \\ R_{V_{LOW_D}} = 20K \end{cases}$$

#3. HCLP calculation

Due to, $V_{V_{LOW}} = 0.847$;

$$90\% = \frac{8.016 - 2 \times 0.847}{6 \cdot V_{HCLP} - 2 \times 0.847} \rightarrow V_{HCLP} = 1.453V$$

$$\frac{2.21}{R_{HCLP_U} + R_{HCLP_D}} = \frac{V_{HCLP}}{R_{HCLP_D}} \rightarrow R_{HCLP_U} = \frac{(2.21 - V_{HCLP}) \times R_{HCLP_D}}{V_{HCLP}} = 0.51411 \times R_{HCLP_D}$$

Because,

$$R_{ISET} = (R_{HCLP_U} + R_{HCLP_D}) // (R_{VLOW_U} + R_{VLOW_D})$$

$$R_{ISET} = \frac{2.21V}{\left(\frac{500\mu A}{5}\right)} = 22K$$

$$R_{HCLP_U} + R_{HCLP_D} = \frac{R_{ISET} \times (R_{VLOW_U} + R_{VLOW_D})}{(R_{VLOW_U} + R_{VLOW_D}) - R_{ISET}} = \frac{22K \times (33K + 20K)}{(33K + 20K) - 22K} = 37.61K$$

Set

$$\begin{cases} R_{HCLP_U} = 12.77K \approx 13K \\ R_{HCLP_D} = 24.84K \approx 24K \end{cases}$$

#4. Fs calculation

$$f_{DIM} = \frac{30 \cdot 10^{-6}}{(3 \cdot V_{HCLP} - V_{LOW}) \cdot C_{FSET}}$$

So,

$$C_{FSET} = 8.55nF \approx 8.2nF$$

#5 The design Result

Conditions			
R _{HCLP_U}	13K ohm	R _{HCLP_D}	24K ohm
R _{VLOW_U}	33K ohm	R _{VLOW_D}	20K ohm
R _{DIMI}	0.1K ohm	C _{FSET}	8.2nF

#6. Final result

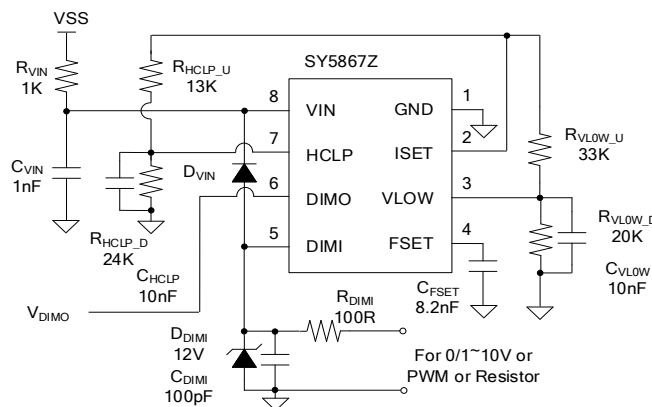
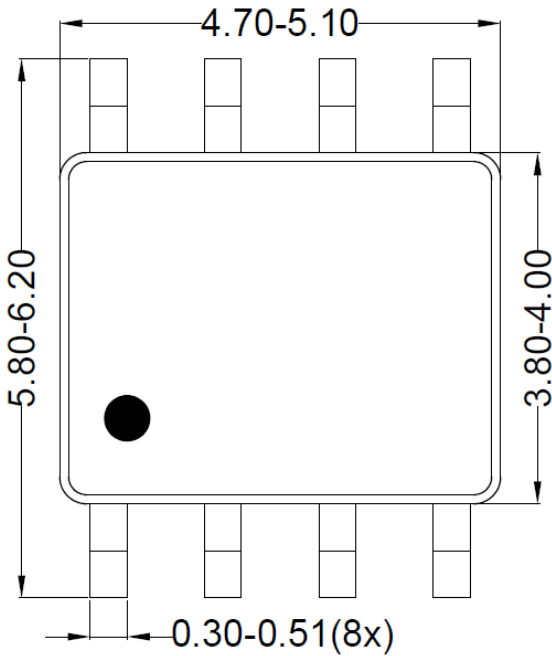
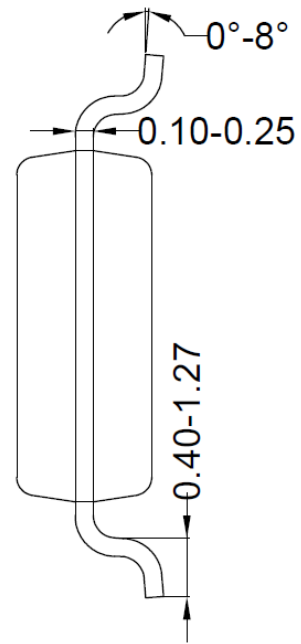


Fig.15 Final Circuit

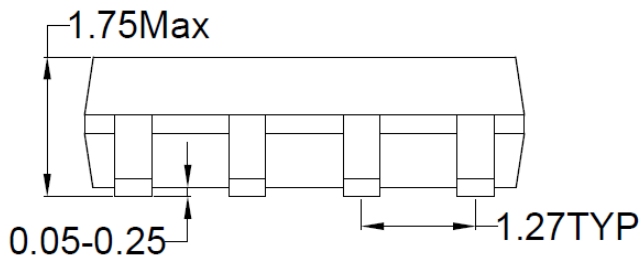
SO8 Package Outline & PCB Layout Design



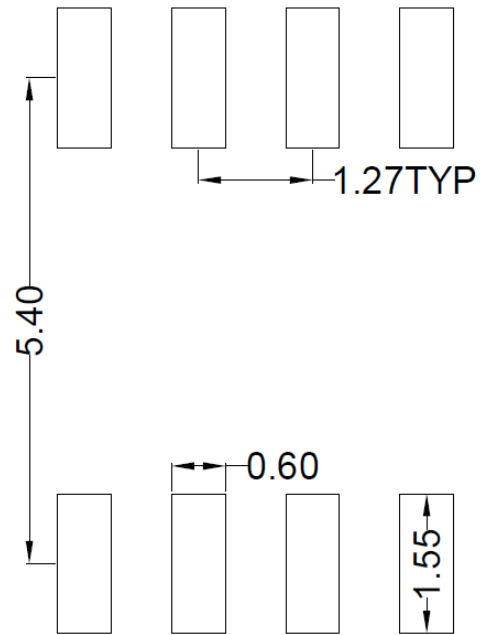
Top View



Side View



Front View

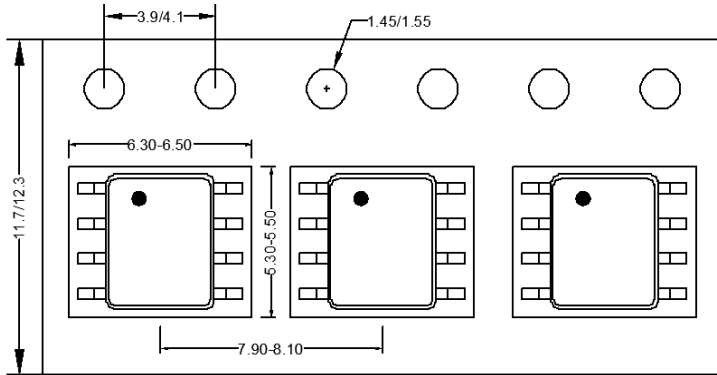


**Recommended Pad Layout
(Reference only)**

Notes: All dimension in millimeter and exclude mold flash & metal burr.

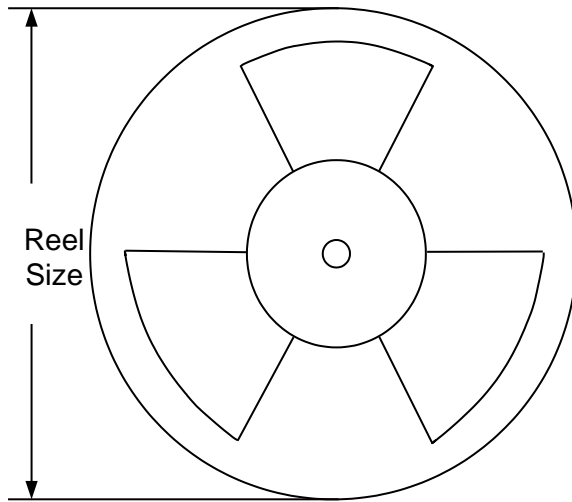
Taping & Reel Specification

1. Taping orientation for packages (SO8)



Feeding direction →

2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SO8	12	8	13"	400	400	2500

Revision History

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
March 27,2026	Revision 1.0	Initial Release

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